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Orderable: EVM orderable	Designed for: Public Release	Mod. Date: 2/2/2018
TID #: N/A	Project Title: TIDA-01581	
Number: XX###	Rev: E1	Sheet Title: Boost LED Driver
Drawn By: Garrett Satterfield	Assembly Variant: Only Populated	Sheet: 1 of 2
Engineer: Garrett Satterfield	File: TIDA01581_1_SchDoc	Size: B
	Contact: http://www.ti.com/support	



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ZZ1

Assembly Note
These assemblies are ESD sensitive. ESD precautions shall be observed.

ZZ2

Assembly Note
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ3

Assembly Note
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.



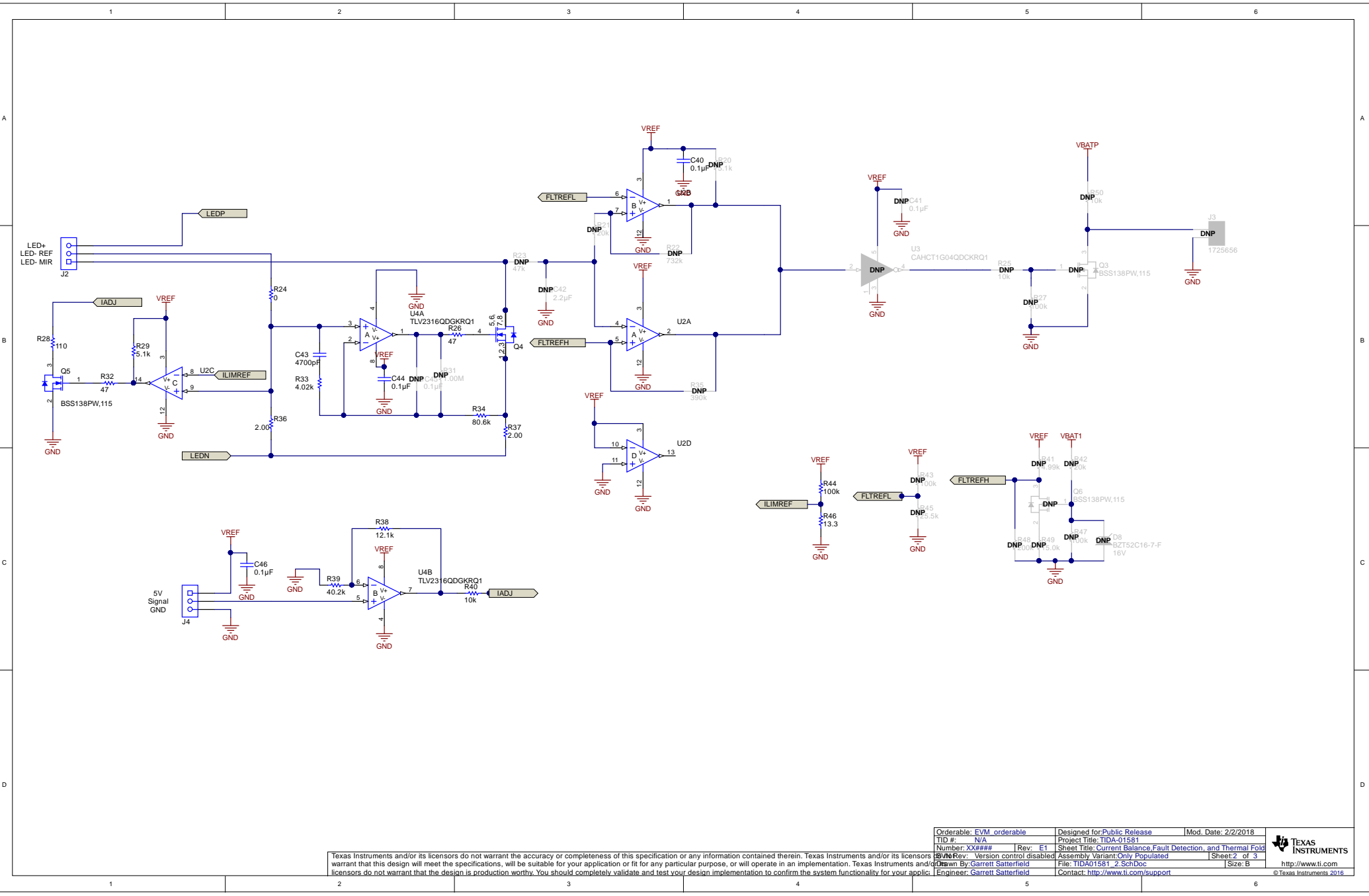
PCB Number: XX####
PCB Rev: E1



Orderable: EVM_orderable	Designed for: Public Release	Mod. Date: 11/7/2017
TID #: N/A	Project Title: TIDA-01581	
Number: XX###	Rev: E1	Sheet Title: Hardware
SVN Rev: Version control disabled	Assembly Variant: Only Populated	Sheet: 2 of 2
Drawn By: Engineer: Garrett Satterfield	File: TIDA01581_Hardware.SchDoc	Size: B
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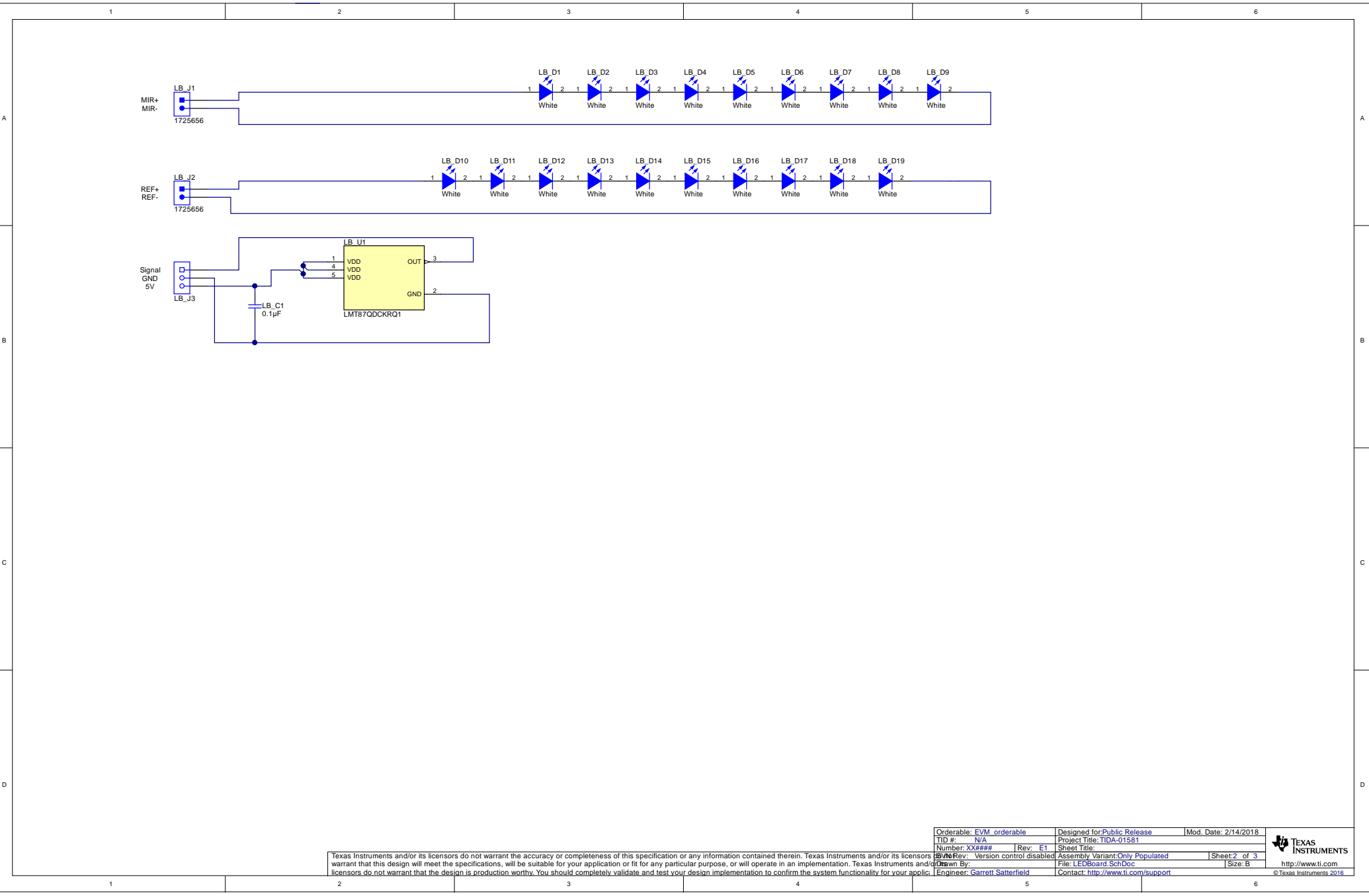


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Orderable: EVM orderable	Designed for: Public Release	Mod. Date: 2/2/2018
TID #: N/A	Project Title: TIDA-01581	
Number: XX###	Rev: E1	Sheet Title: Current Balance, Fault Detection, and Thermal Fold
Drawn By: Garrett Satterfield	Assembly Variant: Only Populated	Sheet 2 of 3
Engineer: Garrett Satterfield	File: TIDA01581_2_SchDoc	Size: B
	Contact: http://www.ti.com/support	



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Orderable: EVM_orderable	Designed for: Public Release	Mod. Date: 2/14/2018
TID #: N/A	Project Title: TIDA-01581	
Number: XX###	Rev: E1	Sheet: 2 of 3
Drawn By: Version control disabled	Assembly Variant: Only Populated	Size: B
Engineer: Garrett Satterfield	File: LEDBoard_SchDoc	Contact: http://www.ti.com/support



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